

# 2SK1764

# Silicon N Channel MOS FET

REJ03G0970-0200

(Previous: ADE-208-1317)

Rev.2.00 Sep 07, 2005

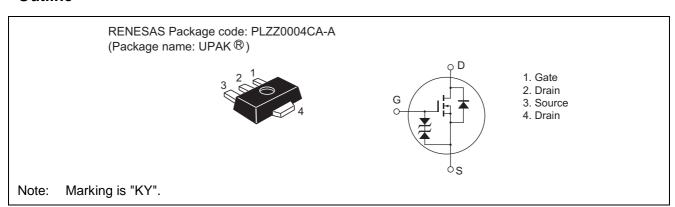
### **Application**

- Low frequency amplifier
- High speed switching

#### **Features**

- Low on-resistance
- High speed switching
- 4 V Gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC-DC converter

#### **Outline**



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# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	60	V
Gate to source voltage	V <sub>GSS</sub>	±20	V
Drain current	I <sub>D</sub>	2	Α
Drain peak current	I <sub>D(pulse)</sub> *1	4	Α
Body to drain diode reverse drain current	I <sub>DR</sub>	2	Α
Channel power dissipation	Pch <sub>*2</sub>	1	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  100  $\mu$ s, duty cycle  $\leq$  10 %

2. Value on the alumina ceramic board (12.5 x 20 x 0.7 mm)

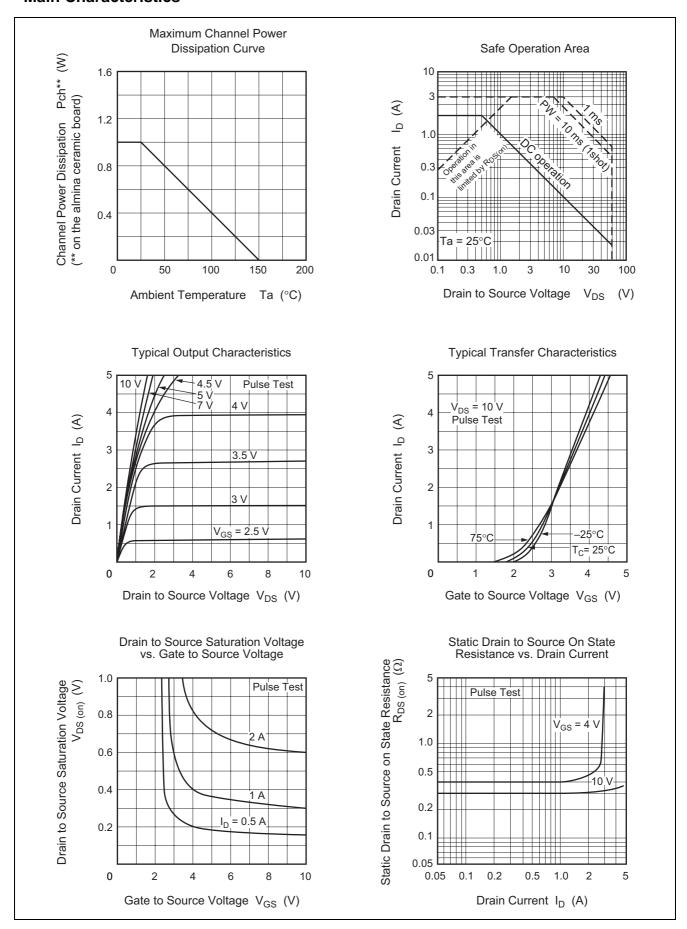
### **Electrical Characteristics**

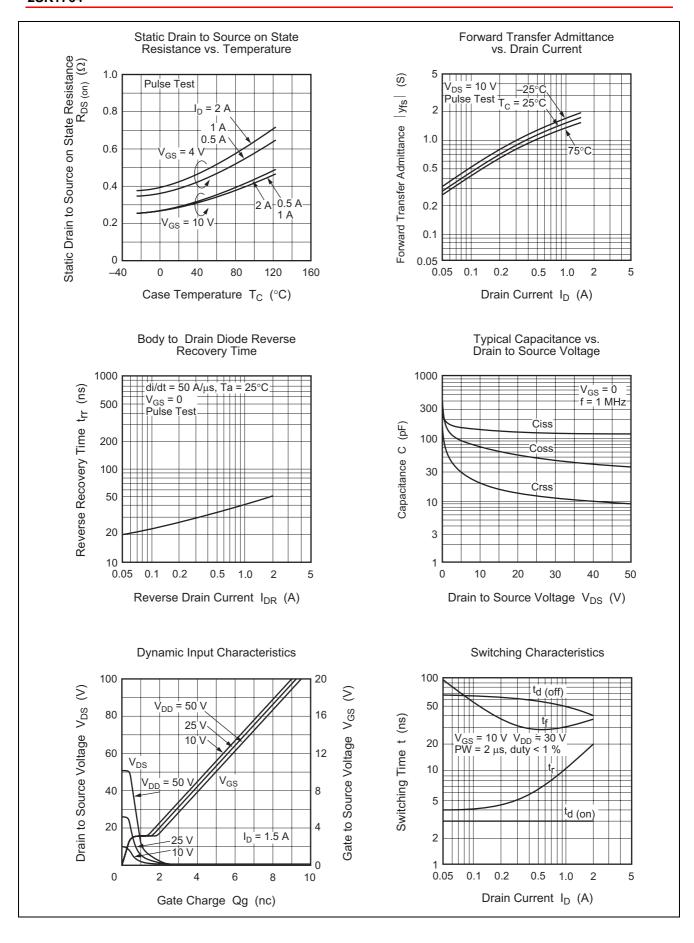
 $(Ta = 25^{\circ}C)$ 

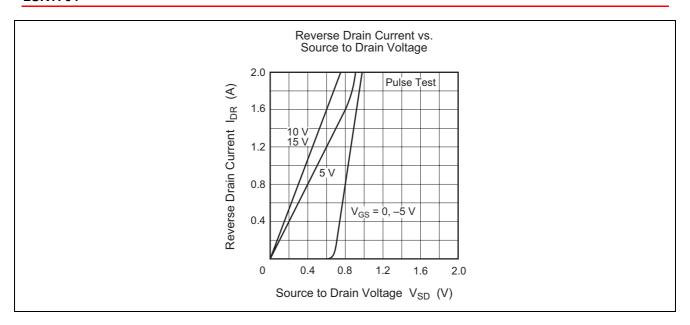
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1	_	2	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Drain to source cutoff current	I <sub>DSS</sub>	_	_	10	μΑ	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0
Gate to source cutoff current	I <sub>GSS</sub>	_	_	±5	μΑ	$V_{GS} = \pm 15 \text{ V}, V_{DS} = 0$
Static drain to source on state	R <sub>DS(on)1</sub>	_	0.3	0.45	Ω	$V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}^{*3}$
resistance						
Static drain to source on state	R <sub>DS(on)2</sub>	-	0.4	0.60	Ω	$V_{GS} = 4 \text{ V}, I_D = 1 \text{ A}^{*3}$
resistance						
Forward transfer admittance	y <sub>fs</sub>	0.9	1.7	_	S	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ A}^{*3}$
Input capacitance	Ciss	_	140	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	75	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	20	_	pF	
Turn on time	t <sub>on</sub>	_	18	_	ns	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ A}^{*3},$
Turn off time	t <sub>off</sub>	_	80	_	ns	$R_L = 30 \Omega$

Note: 3. Pulse Test

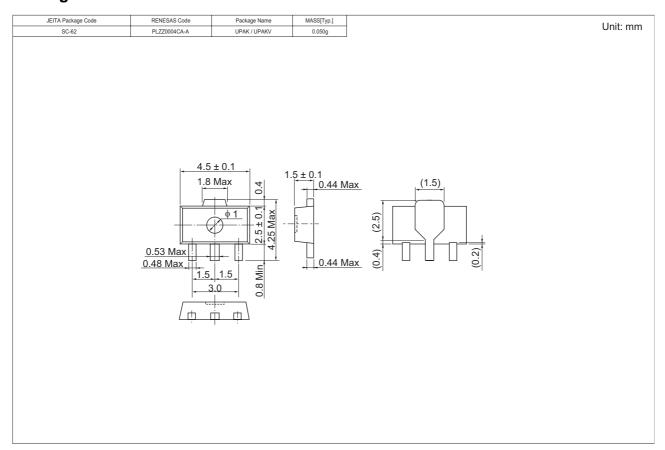
#### **Main Characteristics**







## **Package Dimensions**



## **Ordering Information**

Part Name	Quantity	Shipping Container
2SK1764KYTL-E	3000 pcs	Taping, ¢178 mm Reel
2SK1764KYTR-E	3000 pcs	Taping, φ178 mm Reel

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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